# DATA SHEET

## **74LV259** 8-bit addressable latch

Product specification
Supersedes data of 1997 Jun 06
IC24 Data Handbook

1998 May 20







#### 8-bit addressable latch

74LV259

#### **FEATURES**

- Optimized for low voltage applications: 1.0 to 3.6 V
- Accepts TTL input levels between V<sub>CC</sub> = 2.7 V and V<sub>CC</sub> = 3.6 V
- Typical V<sub>OLP</sub> (output ground bounce) < 0.8 V at V<sub>CC</sub> = 3.3 V,  $T_{amb}$  = 25°C
- Typical  $V_{OHV}$  (output  $V_{OH}$  undershoot) > 2 V at  $V_{CC}$  = 3.3 V,  $T_{amb}$  = 25°C
- Combines demultiplexer and 8-bit latch
- Serial-to-parallel capability
- Output from each storage bit available
- Random (addressable) data entry
- Easily expandable
- Common reset input
- Useful as a 3-to-8 active HIGH decoder
- Output capability: standard
- I<sub>CC</sub> category: MSI

#### **DESCRIPTION**

The 74LV259 is a low-voltage CMOS device and is pin and function compatible with 74HC/HCT259.

The 74LV259 is a high-speed 8-bit addressable latch designed for general purpose storage applications in digital systems. The 74LV259 is a multifunction device capable of storing single-line data in eight addressable latches, and also 3-to-8 decoder and demultiplexer, with active HIGH outputs ( $Q_0$  to  $Q_7$ ), functions are available. The 74LV259 also incorporate an active LOW common reset ( $\overline{\rm MR}$ ) for resetting all latches, as well as an active LOW enable input ( $\overline{\rm LE}$ ). The 74LV259 has four modes of operation as shown in the mode select table. In the addressable latch mode, data on the data line (D) is written into the addressed latch. The addressed latch will follow the data input with all non-addressed latches remaining in their previous states and are unaffected by the data or address inputs.

In the 3-to-8 decoding or demultiplexing mode, the addressed output follows the state of the D input with all other outputs in the LOW state. In the reset mode all outputs are LOW and unaffected by the address (A $_0$  to A $_2$ ) and date (D) input. When operating the 74LV259 as an addressable latch, changing more than one bit of address could impose a transient-wrong address. Therefore, this should only be done while in the memory mode. The mode select table summarizes the operations of the 74LV259.

#### **QUICK REFERENCE DATA**

GND = 0 V;  $T_{amb} = 25^{\circ}C$ ;  $t_r = t_f \le 2.5 \text{ ns}$ 

| SYMBOL                             | PARAMETER   | CONDITIONS   | TYPICAL        | UNIT |
|------------------------------------|---|--|----------------|------|
| t <sub>PHL</sub> /t <sub>PLH</sub> | Propagation delay D, A <sub>n</sub> to Q <sub>n</sub> LE to Q <sub>n</sub> MR to Q <sub>n</sub> | $C_L = 15 \text{ pF};$<br>$V_{CC} = 3.3 \text{ V}$ | 17<br>16<br>14 | ns   |
| C <sub>I</sub>                     | Input capacitance   |  | 3.5            | pF   |
| C <sub>PD</sub>                    | Power dissipation capacitance per latch   | $V_I = GND \text{ to } V_{CC}^1$                   | 19             | pF   |

#### NOTE:

 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz;  $C_L$  = output load capacity in pF;

 $f_0$  = output frequency in MHz;  $V_{CC}$  = supply voltage in V;

 $\sum (C_L \times V_{CC}^2 \times f_0) = \text{sum of the outputs.}$ 

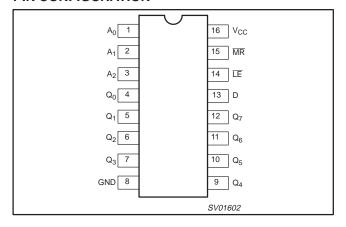
#### **ORDERING INFORMATION**

| PACKAGES                    | TEMPERATURE RANGE | OUTSIDE NORTH AMERICA | NORTH AMERICA | PKG. DWG. # |
|-----------------------------|-------------------|-----------------------|---------------|-------------|
| 16-Pin Plastic DIL          | -40°C to +125°C   | 74LV259 N             | 74LV259 N     | SOT38-4     |
| 16-Pin Plastic SO           | -40°C to +125°C   | 74LV259 D             | 74LV259 D     | SOT109-1    |
| 16-Pin Plastic SSOP Type II | -40°C to +125°C   | 74LV259 DB            | 74LV259 DB    | SOT338-1    |
| 16-Pin Plastic TSSOP Type I | -40°C to +125°C   | 74LV259 PW            | 74LV259PW DH  | SOT403-1    |

<sup>1.</sup>  $C_{PD}$  is used to determine the dynamic power dissipation (P  $_{D}$  in  $\mu W)$ 

74LV259

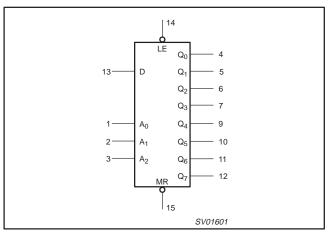
#### **PIN CONFIGURATION**



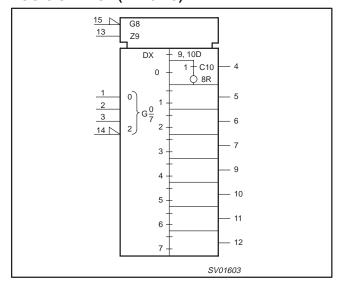
#### **PIN DESCRIPTION**

| PIN<br>NUMBER                | SYMBOL                           | FUNCTION                             |
|------------------------------|----------------------------------|--------------------------------------|
| 1, 2, 3                      | A <sub>0</sub> to A <sub>2</sub> | Address inputs                       |
| 4, 5, 6, 7, 9,<br>10, 11, 12 | Q <sub>0</sub> to Q <sub>7</sub> | Latch outputs                        |
| 8                            | GND                              | Ground (0 V)                         |
| 13                           | D                                | Data input                           |
| 14                           | LE                               | Latch enable input (active LOW)      |
| 15                           | MR                               | Conditional reset input (active LOW) |
| 16                           | V <sub>CC</sub>                  | Positive supply voltage              |

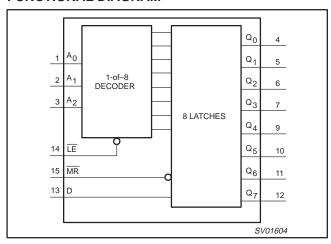
#### **LOGIC SYMBOL**



#### LOGIC SYMBOL (IEEE/IEC)



#### **FUNCTIONAL DIAGRAM**



#### **MODE SELECT TABLE**

| LE | MR | MODE                                |  |  |  |  |  |  |
|----|----|-------------------------------------|--|--|--|--|--|--|
| L  | Н  | Addressable latch                   |  |  |  |  |  |  |
| Н  | Н  | emory                               |  |  |  |  |  |  |
| L  | L  | Active HIGH 8-channel demultiplexer |  |  |  |  |  |  |
| Н  | L  | Reset                               |  |  |  |  |  |  |

#### 8-bit addressable latch

74LV259

#### **FUNCTION TABLE**

| ODEDATING MODES           |    |    | INP | UTS            |                |                |       |       |                | OUTI  | PUTS  |       |       |                |
|---------------------------|----|----|-----|----------------|----------------|----------------|-------|-------|----------------|-------|-------|-------|-------|----------------|
| OPERATING MODES           | MR | LE | D   | A <sub>0</sub> | A <sub>1</sub> | A <sub>2</sub> | $Q_0$ | $Q_1$ | Q <sub>2</sub> | $Q_3$ | $Q_4$ | $Q_5$ | $Q_6$ | Q <sub>7</sub> |
| Master reset              | L  | Н  | Х   | Х              | Х              | Х              | L     | L     | L              | L     | L     | L     | L     | L              |
|                           | L  | L  | d   | L              | L              | L              | Q=d   | L     | L              | L     | L     | L     | L     | L              |
|                           | L  | L  | d   | Н              | L              | L              | L     | Q=d   | L              | L     | L     | L     | L     | L              |
| Demolitical               | L  | L  | d   | L              | Н              | L              | L     | L     | Q=d            | L     | L     | L     | L     | L              |
| Demultiplex (active HIGH) | L  | L  | d   | Н              | Н              | L              | L     | L     | L              | Q=d   | L     | L     | L     | L              |
| decoder<br>(when D = H)   | L  | L  | d   | L              | L              | Н              | L     | L     | L              | L     | Q=d   | L     | L     | L              |
| (When b = 11)             | L  | L  | d   | Н              | L              | Н              | L     | L     | L              | L     | L     | Q=d   | L     | L              |
|                           | L  | L  | d   | L              | Н              | Н              | L     | L     | L              | L     | L     | L     | Q=d   | L              |
|                           | L  | L  | d   | Н              | Н              | Н              | L     | L     | L              | L     | L     | L     | L     | Q=d            |
| Store (do nothing)        | Н  | Н  | Х   | Х              | Х              | Х              | q0    | q1    | q2             | q3    | q4    | q5    | q6    | q7             |
|                           | Н  | L  | d   | L              | L              | L              | Q=d   | q1    | q2             | q3    | q4    | q5    | q6    | q7             |
|                           | Н  | L  | d   | Н              | L              | L              | q0    | Q=d   | q2             | q3    | q4    | q5    | q6    | q7             |
|                           | Н  | L  | d   | L              | Н              | L              | q0    | q1    | Q=d            | q3    | q4    | q5    | q6    | q7             |
| Addrosophic lateb         | Н  | L  | d   | Н              | Н              | L              | q0    | q1    | q2             | Q=d   | q4    | q5    | q6    | q7             |
| Addressable latch         | Н  | L  | d   | L              | L              | Н              | q0    | q1    | q2             | q3    | Q=d   | q5    | q6    | q7             |
|                           | Н  | L  | d   | Н              | L              | Н              | q0    | q1    | q2             | q3    | q4    | Q=d   | q6    | q7             |
|                           | Н  | L  | d   | L              | Н              | Н              | q0    | q1    | q2             | q3    | q4    | q5    | Q=q   | q7             |
|                           | Н  | L  | d   | Н              | Н              | Н              | q0    | q1    | q2             | q3    | q4    | q5    | q6    | Q=d            |

#### NOTES:

HIGH voltage level

LOW voltage level

X =

HIGH or LOW data one set-up time prior to the LOW-to-HIGH  $\overline{\text{LE}}$  transition lower case letters indicate the state of the referenced output established during the last cycle established during the last cycle in which it was addressed or cleared

#### **RECOMMENDED OPERATING CONDITIONS**

| SYMBOL                          | PARAMETER                                       | CONDITIONS   | MIN         | TYP         | MAX               | UNIT |
|---------------------------------|---|--|-------------|-------------|-------------------|------|
| V <sub>CC</sub>                 | DC supply voltage                               | 1.0  | 3.3         | 3.6         | V                 |      |
| VI                              | Input voltage                                   |  | 0           | _           | V <sub>CC</sub>   | V    |
| Vo                              | Output voltage                                  |  | 0           | _           | V <sub>CC</sub>   | V    |
| T <sub>amb</sub>                | Operating ambient temperature range in free air | See DC and AC characteristics  | -40<br>-40  |             | +85<br>+125       | °C   |
| t <sub>r</sub> , t <sub>f</sub> | Input rise and fall times                       | $V_{CC} = 1.0V \text{ to } 2.0V$<br>$V_{CC} = 2.0V \text{ to } 2.7V$<br>$V_{CC} = 2.7V \text{ to } 3.6V$ | -<br>-<br>- | -<br>-<br>- | 500<br>200<br>100 | ns/V |

1. The LV is guaranteed to function down to  $V_{CC}$  = 1.0V (input levels GND or  $V_{CC}$ ); DC characteristics are guaranteed from  $V_{CC}$  = 1.2V to  $V_{CC}$  = 5.5V.

#### 8-bit addressable latch

74LV259

#### **ABSOLUTE MAXIMUM RATINGS<sup>1, 2</sup>**

In accordance with the Absolute Maximum Rating System (IEC 134). Voltages are referenced to GND (ground = 0 V).

| SYMBOL                                  | PARAMETER   | CONDITIONS  | RATING            | UNIT |
|---|---|---|-------------------|------|
| V <sub>CC</sub>                         | DC supply voltage   |   | -0.5 to +4.6      | V    |
| ± I <sub>IK</sub>                       | DC input diode current  | $V_{I} < -0.5 \text{ or } V_{I} > V_{CC} + 0.5V$  | 20                | mA   |
| ± I <sub>OK</sub>                       | DC output diode current   | $V_{O} < -0.5 \text{ or } V_{O} > V_{CC} + 0.5V$  | 50                | mA   |
| ±I <sub>O</sub>                         | DC output source or sink current  – standard outputs  | $-0.5V < V_O < V_{CC} + 0.5V$   | 25                | mA   |
| ±I <sub>GND</sub> ,<br>±I <sub>CC</sub> | DC V <sub>CC</sub> or GND current for types with – standard outputs   |   | 50                | mA   |
| T <sub>stg</sub>                        | Storage temperature range   |   | –65 to +150       | °C   |
| P <sub>TOT</sub>                        | Power dissipation per package  – plastic DIL  – plastic mini-pack (SO)  – plastic shrink mini-pack (SSOP and TSSOP) | for temperature range: -40 to +125°C above +70°C derate linearly with 12 mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K | 750<br>500<br>400 | mW   |

#### NOTES:

#### DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

|                 |  |   |      |                  | LIMITS |         |          |            |
|-----------------|--|---|------|------------------|--------|---------|----------|------------|
| SYMBOL          | PARAMETER  | TEST CONDITIONS   | -4   | 0°C to +8        | 5°C    | -40°C t | o +125°C | UNIT       |
|                 |  |   | MIN  | TYP <sup>1</sup> | MAX    | MIN     | MAX      | 1          |
|                 |  | V <sub>CC</sub> = 1.2 V   | 0.9  |                  |        | 0.9     |          |            |
| V <sub>IH</sub> | voltage  |   | 1.4  |                  |        | 1.4     |          |            |
|                 | Vollago  | V <sub>CC</sub> = 2.7 to 3.6 V  | 2.0  |                  |        | 2.0     |          | 1          |
|                 |  | V <sub>CC</sub> = 1.2 V   |      |                  | 0.3    |         | 0.3      |            |
| V <sub>IL</sub> | LOW level Input voltage                              | V <sub>CC</sub> = 2.0 V   |      |                  | 0.6    |         | 0.6      | <b>1</b> ∨ |
|                 | Voltage  | V <sub>CC</sub> = 2.7 to 3.6 V  |      |                  | 0.8    |         | 0.8      | 1          |
|                 |  | $V_{CC} = 1.2 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 100 \mu\text{A}$ |      | 1.2              |        |         |          |            |
| l .,            | HIGH level output                                    | $V_{CC} = 2.0 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 100 \mu\text{A}$ | 1.8  | 2.0              |        | 1.8     |          | 1          |
| V <sub>OH</sub> | voltage; all outputs                                 | $V_{CC} = 2.7 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 100 \mu\text{A}$ | 2.5  | 2.7              |        | 2.5     |          | <b>V</b>   |
|                 |  | $V_{CC} = 3.0 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 100 \mu\text{A}$ | 2.8  | 3.0              |        | 2.8     |          | 1          |
| V <sub>OH</sub> | HIGH level output<br>voltage;<br>STANDARD<br>outputs | $V_{CC} = 3.0 \text{ V}; V_{I} = V_{IH} \text{ or } V_{IL}; -I_{O} = 6\text{mA}$  | 2.40 | 2.82             |        | 2.20    |          | V          |
|                 |  | $V_{CC} = 1.2 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu\text{A}$  |      | 0                |        |         |          |            |
| ,,              | LOW level output                                     | $V_{CC} = 2.0 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu\text{A}$  |      | 0                | 0.2    |         | 0.2      | 1 .,       |
| V <sub>OL</sub> | voltage; all outputs                                 | $V_{CC} = 2.7 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu\text{A}$  |      | 0                | 0.2    |         | 0.2      | <b>V</b>   |
|                 |  | $V_{CC} = 3.0 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu\text{A}$  |      | 0                | 0.2    |         | 0.2      | 1          |
| V <sub>OL</sub> | LOW level output<br>voltage;<br>STANDARD<br>outputs  | $V_{CC} = 3.0 \text{ V}; V_I = V_{IH} \text{ or } V_{IL;} I_O = 6\text{mA}$       |      | 0.25             | 0.40   |         | 0.50     | V          |

Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the
device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to
absolute-maximum-rated conditions for extended periods may affect device reliability.

<sup>2.</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

74LV259

DC ELECTRICAL CHARACTERISTICS (Continued)
Over recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

|                  |   |  |     | LIMITS           |      |          |      |    |  |  |  |
|------------------|---|--|-----|------------------|------|----------|------|----|--|--|--|
| SYMBOL           | PARAMETER                                     | TEST CONDITIONS  | -40 | °C to +8         | 5°C  | -40°C to | UNIT |    |  |  |  |
|                  |   |  | MIN | TYP <sup>1</sup> | MAX  | MIN      | MAX  |    |  |  |  |
| I <sub>I</sub>   | Input leakage current                         | $V_{CC} = 3.6 \text{ V}; V_I = V_{CC} \text{ or GND}$                      |     |                  | 1.0  |          | 1.0  | μА |  |  |  |
| I <sub>CC</sub>  | Quiescent supply current; MSI                 | $V_{CC} = 3.6 \text{ V}; V_{I} = V_{CC} \text{ or GND}; I_{O} = 0$         |     |                  | 20.0 |          | 160  | μА |  |  |  |
| Δl <sub>CC</sub> | Additional quiescent supply current per input | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}; V_{I} = V_{CC} - 0.6 \text{ V}$ |     |                  | 500  |          | 850  | μА |  |  |  |

#### NOTE:

#### **AC CHARACTERISTICS**

 $\label{eq:gnd} \text{GND} = \text{0V; } t_{\text{f}} = t_{\text{f}} \leq \text{2.5ns; } C_{\text{L}} = \text{50pF; } R_{\text{L}} = \text{1K}\Omega$ 

|                                    | 7 2 1 7 2                                      |                | CONDITION           |     |                  | LIMITS |        |         |      |
|------------------------------------|--|----------------|---------------------|-----|------------------|--------|--------|---------|------|
| SYMBOL                             | PARAMETER                                      | WAVEFORM       | CONDITION           |     | 40 to +85        | °C     | -40 to | +125 °C | UNIT |
|                                    |  |                | V <sub>CC</sub> (V) | MIN | TYP <sup>1</sup> | MAX    | MIN    | MAX     |      |
|                                    |  |                | 1.2                 |     | 105              |        |        |         |      |
| <b>4</b>                           | Propagation delay                              | Figure 2       | 2.0                 |     | 36               | 49     |        | 61      | 20   |
| t <sub>PHL</sub> /t <sub>PLH</sub> | D to Q <sub>n</sub>                            | Figure 2       | 2.7                 |     | 26               | 36     |        | 45      | ns   |
|                                    |  |                | 3.0 to 3.6          |     | 20 <sup>2</sup>  | 29     |        | 36      |      |
|                                    |  |                | 1.2                 |     | 105              |        |        |         |      |
|                                    | Propagation delay                              | Figure 2       | 2.0                 |     | 36               | 49     |        | 61      |      |
| t <sub>PHL</sub> /t <sub>PLH</sub> | $A_n$ to $Q_n$                                 | Figure 3       | 2.7                 |     | 26               | 36     |        | 45      | ns   |
|                                    |  | 1 Г            | 3.0 to 3.6          |     | 20 <sup>2</sup>  | 29     |        | 36      |      |
|                                    |  |                | 1.2                 |     | 100              |        |        |         |      |
|                                    | Propagation delay                              | Figure 4       | 2.0                 |     | 34               | 48     |        | 60      |      |
| t <sub>PHL</sub> /t <sub>PLH</sub> | LE to Q <sub>n</sub>                           | Figure 1       | 2.7                 |     | 25               | 35     |        | 44      | ns   |
|                                    |  |                | 3.0 to 3.6          |     | 19 <sup>2</sup>  | 28     |        | 35      |      |
|                                    |  |                | 1.2                 |     | 90               |        |        |         |      |
|                                    | Propagation delay                              | Figure 4       | 2.0                 |     | 31               | 43     |        | 53      |      |
| t <sub>PHL</sub>                   | MR to Q <sub>n</sub>                           | Figure 4       | 2.7                 |     | 23               | 31     |        | 39      | ns   |
|                                    |  |                | 3.0 to 3.6          |     | 17 <sup>2</sup>  | 25     |        | 31      |      |
|                                    | _  |                | 2.0                 | 34  | 10               |        | 41     |         |      |
| $t_{w}$                            | LE pulse width<br>HIGH or LOW                  | Figure 1       | 2.7                 | 25  | 8                |        | 30     |         | ns   |
|                                    | 111011012011                                   | Т Г            | 3.0 to 3.6          | 20  | 6 <sup>2</sup>   |        | 24     |         |      |
|                                    |  |                | 2.0                 | 34  | 10               |        | 41     |         |      |
| $t_{w}$                            | MR pulse width<br>LOW                          | Figure 4       | 2.7                 | 25  | 8                |        | 30     |         | ns   |
|                                    | 1000   |                | 3.0 to 3.6          | 20  | 6 <sup>2</sup>   |        | 24     |         |      |
|                                    |  |                | 1.2                 |     | 35               |        |        |         |      |
|                                    | Set-up time                                    |                | 2.0                 | 24  | 12               |        | 29     |         |      |
| t <sub>su</sub>                    | D <sub>,</sub> A <sub>n</sub> to <del>LE</del> | Figure 5 and 6 | 2.7                 | 18  | 9                |        | 21     |         | ns   |
|                                    | Hold time Figure                               |                | 3.0 to 3.6          | 14  | 7 <sup>2</sup>   |        | 17     |         |      |
|                                    |  |                | 1.2                 |     | -30              |        |        |         |      |
|                                    |  |                | 2.0                 | 5   | -10              |        | 5      |         |      |
| t <sub>h</sub>                     |  | Figure 5       | 2.7                 | 5   | -8               |        | 5      |         | ns   |
|                                    |  | l l            | 3.0 to 3.6          | 5   | -6 <sup>2</sup>  | 1      | 5      |         |      |

<sup>1.</sup> All typical values are measured at  $T_{amb} = 25$ °C.

74LV259

#### **AC CHARACTERISTICS (Continued)**

GND = 0V;  $t_r = t_f \le 2.5 \text{ns}$ ;  $C_L = 50 \text{pF}$ ;  $R_L = 1 \text{K}\Omega$ 

| SYMBOL         | PARAMETER                         | WAVEFORM | CONDITION           |  | –40 to +85 °C |     |     | ⊦125 °C | UNIT |
|----------------|-----------------------------------|----------|---------------------|--|---------------|-----|-----|---------|------|
| 31MBOL         | TANAMETER                         | WAVE ORM | V <sub>CC</sub> (V) | V <sub>CC</sub> (V) MIN TYP <sup>1</sup> MAX |               | MIN | MAX | J       |      |
|                |                                   |          | 1.2                 |  | -20           |     |     |         |      |
| ١.             | Hold time<br>A <sub>n</sub> to LE | Figure 6 | 2.0                 | 5  | -7            |     | 5   |         |      |
| t <sub>h</sub> |                                   |          | 2.7                 | 5  | <b>-</b> 5    |     | 5   |         | ns   |
|                |                                   |          | 3.0 to 3.6          | 5  | -42           |     | 5   |         |      |

#### NOTES:

- 1. Unless otherwise stated, all typical values are measured at  $T_{amb} = 25$ °C
- 2. Typical values are measured at  $V_{CC} = 3.3 \text{ V}$ .

#### **AC WAVEFORMS**

$$\begin{split} &V_M=1.5~V~at~V_{CC}\geq 2.7~V~and \leq 3.6V;\\ &V_M=0.5\times V_{CC}~at~V_{CC}<2.7~V~and \geq 4.5~V. \end{split}$$

 $\rm V_{OL}$  and  $\rm V_{OH}$  are the typical output voltage drop that occur with the output load.

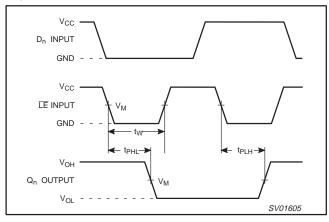


Figure 1. Enable input ( $\overline{\text{LE}}$ ) to output ( $Q_n$ ) propagation delays and the enable input pulse width.

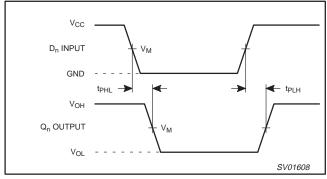


Figure 2. Data input (D) to output (Qn) propagation delays.

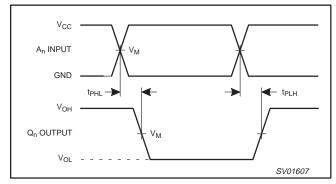


Figure 3. Address inputs  $(A_n)$  to output  $(Q_n)$  propagation delays.

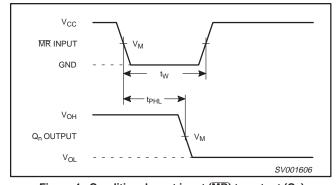


Figure 4. Conditional reset input ( $\overline{MR}$ ) to output ( $Q_n$ ) propagation delays.

74LV259

#### **AC WAVEFORMS (Continued)**

 $V_M = 1.5 \text{ V at } V_{CC} \ge 2.7 \text{ V and } \le 3.6 \text{V};$ 

 $V_{M} = 0.5 \times V_{CC}$  at  $V_{CC} < 2.7 \text{ V}$  and  $\geq 4.5 \text{ V}.$ 

 $_{\rm OL}^{\rm NC}$  and V $_{\rm OH}$  are the typical output voltage drop that occur with the output load.

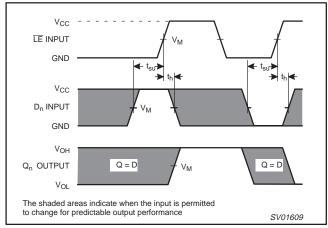


Figure 5. Data set-up and hold times for D input to LE input.

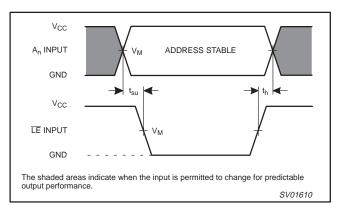


Figure 6. Address set-up and hold times for  $A_n$  inputs to  $\overline{LE}$  input.

#### **TEST CIRCUIT**

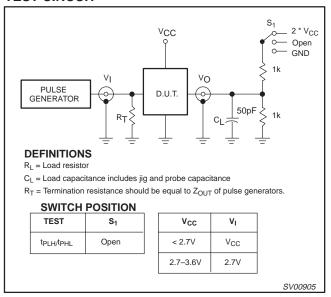


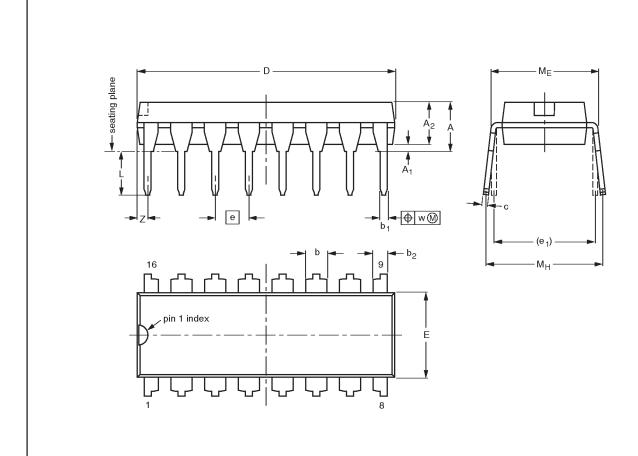
Figure 7. Load circuitry for switching times.

### 8-bit addressable latch

74LV259

DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



#### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT   | A<br>max. | A <sub>1</sub><br>min. | A <sub>2</sub><br>max. | b              | b <sub>1</sub> | b <sub>2</sub> | C              | D <sup>(1)</sup> | E <sup>(1)</sup> | e    | e <sub>1</sub> | L            | ME           | Мн           | w     | Z <sup>(1)</sup><br>max. |
|--------|-----------|------------------------|------------------------|----------------|----------------|----------------|----------------|------------------|------------------|------|----------------|--------------|--------------|--------------|-------|--------------------------|
| mm     | 4.2       | 0.51                   | 3.2                    | 1.73<br>1.30   | 0.53<br>0.38   | 1.25<br>0.85   | 0.36<br>0.23   | 19.50<br>18.55   | 6.48<br>6.20     | 2.54 | 7.62           | 3.60<br>3.05 | 8.25<br>7.80 | 10.0<br>8.3  | 0.254 | 0.76                     |
| inches | 0.17      | 0.020                  | 0.13                   | 0.068<br>0.051 | 0.021<br>0.015 | 0.049<br>0.033 | 0.014<br>0.009 | 0.77<br>0.73     | 0.26<br>0.24     | 0.10 | 0.30           | 0.14<br>0.12 | 0.32<br>0.31 | 0.39<br>0.33 | 0.01  | 0.030                    |

10 mm

#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

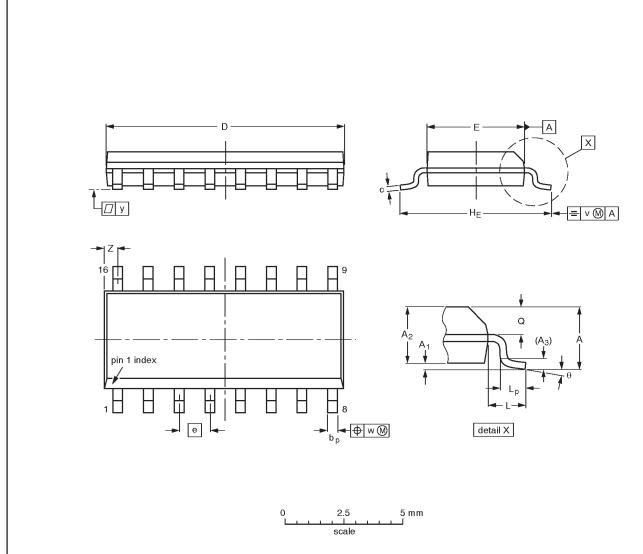
| OUTLINE |     | REFER | EUROPEAN   | ISSUE DATE |  |                                 |
|---------|-----|-------|------------|------------|--|---------------------------------|
| VERSION | IEC | JEDEC | PROJECTION | ISSUE DATE |  |                                 |
| SOT38-4 |     |       |            |            |  | <del>92-11-17</del><br>95-01-14 |

#### 8-bit addressable latch

74LV259

#### SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



#### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| _ |        | •         |                  |                |                |              |                  |                  |                  |       | ,            |       |                |                |      |      |       |                  |    |
|---|--------|-----------|------------------|----------------|----------------|--------------|------------------|------------------|------------------|-------|--------------|-------|----------------|----------------|------|------|-------|------------------|----|
|   | UNIT   | A<br>max. | Α1               | A <sub>2</sub> | A <sub>3</sub> | bp           | С                | D <sup>(1)</sup> | E <sup>(1)</sup> | е     | HE           | L     | Lp             | O              | v    | w    | у     | Z <sup>(1)</sup> | θ  |
|   | mm     | 1.75      | 0.25<br>0.10     | 1.45<br>1.25   | 0.25           | 0.49<br>0.36 | 0.25<br>0.19     | 10.0<br>9.8      | 4.0<br>3.8       | 1.27  | 6.2<br>5.8   | 1.05  | 1.0<br>0.4     | 0.7<br>0.6     | 0.25 | 0.25 | 0.1   | 0.7<br>0.3       | 8° |
| i | inches | 0.069     | 0.0098<br>0.0039 | 0.057<br>0.049 | 0.01           |              | 0.0098<br>0.0075 | 0.39<br>0.38     | 0.16<br>0.15     | 0.050 | 0.24<br>0.23 | 0.041 | 0.039<br>0.016 | 0.028<br>0.020 | 0.01 | 0.01 | 0.004 | 0.028<br>0.012   | 0° |

#### Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

| OUTLINE  |         | REFER    | EUROPEAN | ISSUE DATE |            |                                 |  |
|----------|---------|----------|----------|------------|------------|---------------------------------|--|
| VERSION  | IEC     | JEDEC    | EIAJ     |            | PROJECTION | ISSUE DATE                      |  |
| SOT109-1 | 076E07S | MS-012AC |          |            |            | <del>91-08-13</del><br>95-01-23 |  |

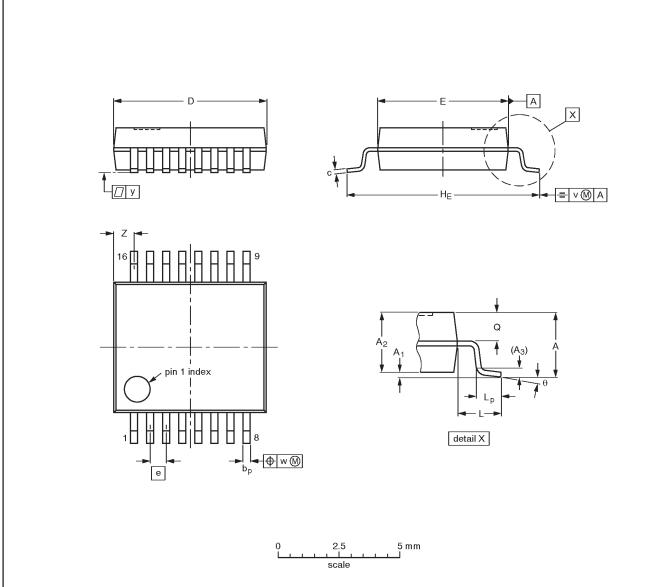
Product specification

#### 8-bit addressable latch

74LV259

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1



#### DIMENSIONS (mm are the original dimensions)

| UNIT | A<br>max. | A <sub>1</sub> | A <sub>2</sub> | A <sub>3</sub> | рb           | С            | D <sup>(1)</sup> | E <sup>(1)</sup> | е    | HE         | L    | Lp           | Q          | v   | w    | у   | Z <sup>(1)</sup> | θ        |
|------|-----------|----------------|----------------|----------------|--------------|--------------|------------------|------------------|------|------------|------|--------------|------------|-----|------|-----|------------------|----------|
| mm   | 2.0       | 0.21<br>0.05   | 1.80<br>1.65   | 0.25           | 0.38<br>0.25 | 0.20<br>0.09 | 6.4<br>6.0       | 5.4<br>5.2       | 0.65 | 7.9<br>7.6 | 1.25 | 1.03<br>0.63 | 0.9<br>0.7 | 0.2 | 0.13 | 0.1 | 1.00<br>0.55     | 8°<br>0° |

#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

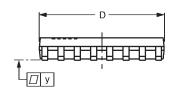
| OUTLINE  |     | EUROPEAN | ISSUE DATE |  |            |                                 |  |
|----------|-----|----------|------------|--|------------|---------------------------------|--|
| VERSION  | IEC | JEDEC    | EIAJ       |  | PROJECTION | ISSUE DATE                      |  |
| SOT338-1 |     | MO-150AC |            |  |            | <del>94-01-14</del><br>95-02-04 |  |

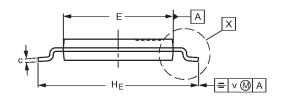
#### 8-bit addressable latch

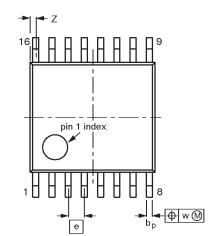
74LV259

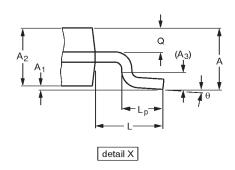
TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1











#### **DIMENSIONS (mm are the original dimensions)**

| UNIT | A<br>max. | Α1           | A <sub>2</sub> | <b>A</b> <sub>3</sub> | рb           | O          | D <sup>(1)</sup> | E <sup>(2)</sup> | Φ    | HE         | ٦   | Lp           | ø          | ٧   | v    | у   | Z <sup>(1)</sup> | θ        |
|------|-----------|--------------|----------------|-----------------------|--------------|------------|------------------|------------------|------|------------|-----|--------------|------------|-----|------|-----|------------------|----------|
| mm   | 1.10      | 0.15<br>0.05 | 0.95<br>0.80   | 0.25                  | 0.30<br>0.19 | 0.2<br>0.1 | 5.1<br>4.9       | 4.5<br>4.3       | 0.65 | 6.6<br>6.2 | 1.0 | 0.75<br>0.50 | 0.4<br>0.3 | 0.2 | 0.13 | 0.1 | 0.40<br>0.06     | 8°<br>0° |

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE  |     | EUROPEAN | ISSUE DATE |  |            |                                   |  |  |
|----------|-----|----------|------------|--|------------|-----------------------------------|--|--|
| VERSION  | IEC | JEDEC    | EIAJ       |  | PROJECTION | ISSUE DATE                        |  |  |
| SOT403-1 |     | MO-153   |            |  |            | <del>-94-07-12-</del><br>95-04-04 |  |  |

## 8-bit addressable latch

74LV259

#### **NOTES**

#### 8-bit addressable latch

74LV259

|  | DEFINITIONS            |  |  |  |  |  |  |  |  |
|--|------------------------|--|--|--|--|--|--|--|--|
| Data Sheet Identification Product Status |                        | Definition   |  |  |  |  |  |  |  |
| Objective Specification                  | Formative or in Design | This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.   |  |  |  |  |  |  |  |
| Preliminary Specification                | Preproduction Product  | This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product. |  |  |  |  |  |  |  |
| Product Specification                    | Full Production        | This data sheet contains Final Specifications. Philips Semiconductors reserves the right to make changes at any time without notice, in order to improve design and supply the best possible product.  |  |  |  |  |  |  |  |

Philips Semiconductors and Philips Electronics North America Corporation reserve the right to make changes, without notice, in the products, including circuits, standard cells, and/or software, described or contained herein in order to improve design and/or performance. Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no license or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified. Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

#### LIFE SUPPORT APPLICATIONS

Philips Semiconductors and Philips Electronics North America Corporation Products are not designed for use in life support appliances, devices, or systems where malfunction of a Philips Semiconductors and Philips Electronics North America Corporation Product can reasonably be expected to result in a personal injury. Philips Semiconductors and Philips Electronics North America Corporation customers using or selling Philips Semiconductors and Philips Electronics North America Corporation Products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors and Philips Electronics North America Corporation for any damages resulting from such improper use or sale.

Philips Semiconductors 811 East Arques Avenue P.O. Box 3409 Sunnyvale, California 94088–3409 Telephone 800-234-7381 © Copyright Philips Electronics North America Corporation 1998 All rights reserved. Printed in U.S.A.

print code

PHILIPS

Date of release: 05-96

Document order number:

9397-750-04442

Let's make things better.



